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IN THE CLAIMS:

Please amend the claims as follows, substituting any amended claim(s) for the corresponding pending claim(s):

1	77. (unchanged) An integrated circuit structure, comprising:
2	a substrate;
3	a field oxide over the substrate, the field oxide having an opening therethrough to a
4	surface of the substrate;
5	a gate electrode over the surface of the substrate and within the opening, the gate
6	electrode having insulating material on a bottom and on two sides of the gate electrode, wherein
7	the insulating material on the bottom of the gate electrode contacts the substrate; and
8	source and drain regions adjacent the insulating material on the gate electrode, each
9	source and drain region including
10	a first portion in the substrate and
11	a second portion on the substrate over the first portion and adjacent to the
12	insulating material on the sides of the gate electrode.

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78. (unchanged) The integrated circuit structure of claim 77, wherein the opening through the 1 substrate has substantially vertical sidewalls. - 2 79. (unchanged) The integrated circuit structure of claim 78, wherein each source and drain 1 region is formed between a sidewall of the opening and the insulating material on the sides of 2 the gate electrode. 3 80. (unchanged) The integrated circuit structure of claim 79, wherein a space between a 1 sidewall of the opening and the insulating material on the sides of the gate electrode is filled 2 with material forming the second portion of one of the source and drain regions. 3 81. (amended) The integrated circuit structure of claim 77, further comprising: 1 LDD regions for the source and drain regions formed within the first portion of each 2 source and drain region. 3 82. (unchanged) The integrated circuit structure of claim 81, wherein the LDD regions are 1 formed in the substrate beneath the insulating material on the sides of the gate electrode. 2

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83. (unchanged) The integrated circuit structure of claim 77, wherein the gate electrode, the insulating material on the sides of the gate electrode, and the second portions of the source and

1 84. (unchanged) The integrated circuit structure of claim 77, an upper surface of the gate 2 electrode is further from a surface of the substrate than an upper surface of the field oxide.

- 1 85. (unchanged) The integrated circuit structure of claim 77, wherein the first and second portions of the source and drain regions are both formed of a semiconductor material.
- 1 86. (unchanged) The integrated circuit structure of claim 77, wherein the second portions of the 2 source and drain regions each form contact regions for source/drain contacts.

Please add the following new claim:

drain regions fill the opening.

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1 87. (newly added) The integrated circuit structure of claim 82, wherein the LDD regions are 2 the first portions of the source and drain regions.